

E36SC05025

125W DC/DC Power Modules











Delphi Series E36SC050, Eighth Brick Family DC/DC Power Modules: 18~75V in, 5.0V/25A out, 125W

The Delphi Series E36SC050, Eighth Brick, 18V~75Vin input, single output, isolated DC/DC converters, are the latest offering from a world leader in power systems technology and manufacturing — Delta Electronics, Inc. This product family provides up to 125 watts of power or 25A of output current. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performance, as well as extremely high reliability under highly stressful operating conditions. Typical efficiency of the 5V/25A module is greater than 91%.

FEATURES

- High efficiency: 91% @ 5V/25A
- Size:

58.4x22.8x11.0mm (2.30"x0.90"x0.43") w/o heat-spreader 58.4x22.8x12.7mm (2.30"x0.90"x0.50") with heat-spreader

- Industry standard footprint and pinout
- Fixed frequency operation
- SMD and through-hole versions
- Input UVLO
- OTP and output OVP
- Output OCP hiccup mode
- Output voltage trim down: -20%
- Output voltage trim up: +10% at Vin>20V
- Monotonic startup into normal and pre-biased loads
- 1500V isolation and basic insulation
- No minimum load required
- No negative current during power or enable on/off
- ISO 9001, TL 9000, ISO 14001, QS 9000,
- OHSAS18001 certified manufacturing facility
- UL/cUL 60950-1 (US & Canada) recognized

OPTIONS

- Negative or Positive remote On/Off
- Surface-mount/Through-hole
- Open frame/Heat spreader

APPLICATIONS

- Optical Transport
- Data Networking
- Communications
- Servers



TECHNICAL SPECIFICATIONS

PARAMETER	NOTES and CONDITIONS	E36SC05025 (Standard)			
		Min.	Тур.	Max.	Unit
ABSOLUTE MAXIMUM RATINGS					
nput Voltage				0.0	Vdd
Continuous	100	0		80	Vdd
Transient (100ms)	100ms	40		100	Vdc
Operating Ambient Temperature Storage Temperature		-40 -55		85 125	°C ℃
nput/Output Isolation Voltage		-55		1500	Vdo
NPUT CHARACTERISTICS				1300	Vuc
Operating Input Voltage		18	48	75	Vdd
Input Under-Voltage Lockout			.0	, 0	
Turn-On Voltage Threshold		16.5	17.2	17.9	Vde
Turn-Off Voltage Threshold		15.5	16.2	16.9	Vd
Lockout Hysteresis Voltage		0.3	1.0	1.8	Vd
Maximum Input Current	Full Load, 18Vin			8.9	Α
No-Load Input Current	Vin=48V, Io=0A		55		m,
Off Converter Input Current	Vin=48V, Io=0A		5		m/
Inrush Current (I ² t)				1	A^2
Input Reflected-Ripple Current	P-P thru 12μH inductor, 5Hz to 20MHz		20		m.
Input Voltage Ripple Rejection	120 Hz		50		dE
OUTPUT CHARACTERISTICS	Vi- 40V I- I- T 0500	4.005		E 075	
Output Voltage Set Point	Vin=48V, Io=Io.max, Tc=25°C	4.925	5	5.075	Vc
Output Regulation Over Load	lo=lo, min to lo, max			±5	
Over Load Over Line	Vin=18V to 75V			±5 ±5	m m
Over Line Over Temperature	VIN=18V to 75V Tc=-40°C to 85°C			±50	m m
Total Output Voltage Range	Over sample load, line and temperature	4.85	5	5.15	m \
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth	4.03	J	5.15	,
Peak-to-Peak	Vin=48V, Full Load, 1μF ceramic, 10μF tantalum		70		m
RMS	Vin=48V, Full Load, 1µF ceramic, 10µF tantalum		23		m
Operating Output Current Range	Vin=18V to75V	0		25	Α
Output Over Current Protection(hiccup mode)	Output Voltage 10% Low	27.5		35	Α
YNAMIC CHARACTERISTICS					
Output Voltage Current Transient	48Vin, 10μF Tan & 1μF Ceramic load cap, 0.1A/μs				
Positive Step Change in Output Current	75% lo.max to 50% lo.max		200		m
Negative Step Change in Output Current	50% lo.max to 75% lo.max		200		m
Settling Time (within 1% Vout nominal)			200		μ
Turn-On Transient					
Start-Up Time, From On/Off Control			55		m
Start-Up Time, From Input Output Capacitance (note1)	Full loads 50/ asserboat of Vest at startum		55	10000	m u
FFICIENCY	Full load; 5% overshoot of Vout at startup			10000	μ
100% Load	Vin=24V		90.5		9/
100% Load	Vin=24V Vin=48V		91		%
60% Load	Vin=48V		91.5		9/
SOLATION CHARACTERISTICS	VIII-10V		01.0		,
Input to Output				1500	Vo
Isolation Resistance		10		1000	M
Isolation Capacitance			1000		р
EATURE CHARACTERISTICS					
Switching Frequency			300		Kŀ
ON/OFF Control, Negative Remote On/Off logic					
Logic Low (Module On)	Von/off			0.8	\
Logic High (Module Off)	Von/off	3.0		5	١
ON/OFF Control, Positive Remote On/Off logic					
Logic Low (Module Off)	Von/off			0.8	٧
Logic High (Module On)	Von/off	3.0		5	\
N/OFF Current (for both remote on/off logic)	Ion/off at Von/off=0.0V				m
eakage Current (for both remote on/off logic)	Logic High, Von/off=5V				
Output Voltage Trim Range(note 2)	Pout ≤ max rated power,lo ≤ lo.max	-20		10	9/
Output Voltage Remote Sense Range	Pout ≤ max rated power, lo ≤ lo.max	-20		10	9/
<u> </u>	Over full temp range; % of nominal Vout	115		140	9/
Output Over-Voltage Protection	Over full temp range, % of nonlinal vout	110		140	7
	1- 000/ -f 1 T- 0500 -i-fl 0001 FM		7.3		Mho
ENERAL SPECIFICATIONS					
ENERAL SPECIFICATIONS MTBF	Io=80% of Io, max; Ta=25°C, airflow rate=300LFM			1	gra
ENERAL SPECIFICATIONS MTBF Weight	Without heat spreader		24.6		
ENERAL SPECIFICATIONS MTBF Weight	Without heat spreader With heat spreader		33.2		gra
Output Over-Voltage Protection IENERAL SPECIFICATIONS MTBF Weight Weight Over-Temperature Shutdown (Without heat spreader)	Without heat spreader With heat spreader Refer to Figure 18 for Hot spot 1 location (48Vin,80% lo, 200LFM,Airflow from Vin+ to Vin-)				
ENERAL SPECIFICATIONS MTBF Weight Weight	Without heat spreader With heat spreader Refer to Figure 18 for Hot spot 1 location		33.2		@rai

 $(T_A=25^{\circ}C, airflow rate=100 LFM, V_{in}=48Vdc, nominal Vout unless otherwise noted.)$

Note1: For applications with higher output capacitive load, please contact Delta. Note2: Trim down range -20% for 18Vin ~75Vin, Trim up range +10% for 20Vin ~ 75Vin.

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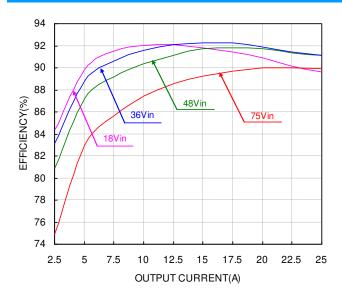


Figure 1: Efficiency vs. load current for 18V, 36V, 48V, and 75V input voltage at 25°C.

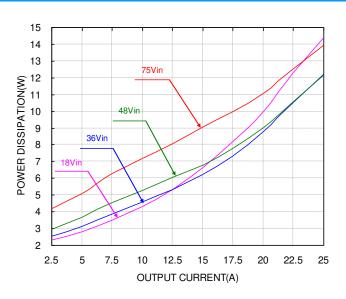


Figure 2: Power dissipation vs. load current for 18V, 36V, 48V, and 75V input voltage at 25°C.

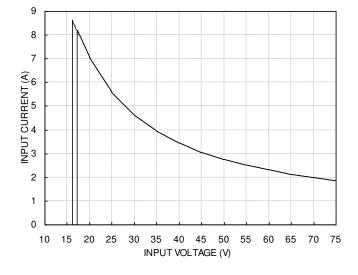


Figure 3: Full load input characteristics at room temperature.



For Negative Remote On/Off Logic

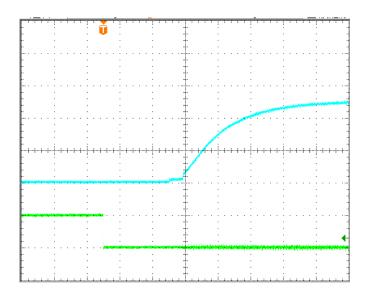


Figure 4: Turn-on transient at zero load current (10ms/div). Vin=48V. Top Trace: Vout; 2V/div; Bottom Trace: ON/OFF input: 5V/div.

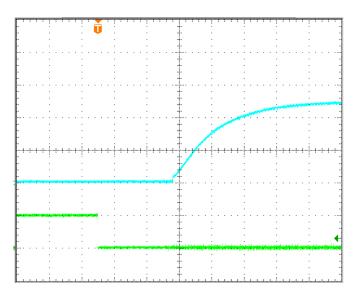


Figure 5: Turn-on transient at full load current (10ms/div). Vin=48V. Top Trace: Vout: 2V/div; Bottom Trace: ON/OFF input: 5V/div.

For Input Voltage Start up

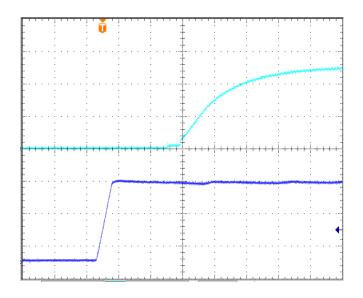


Figure 6: Turn-on transient at zero load current (10 ms/div). Top Trace: Vout; 2V/div; Bottom Trace: input voltage: 20V/div.

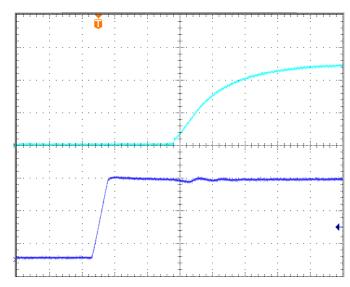
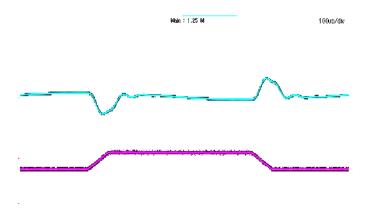


Figure 7: Turn-on transient at full load current (10 ms/div). Top Trace: Vout; 2V/div; Bottom Trace: input voltage: 20V/div.





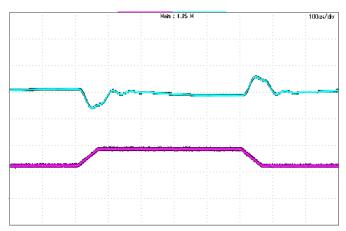
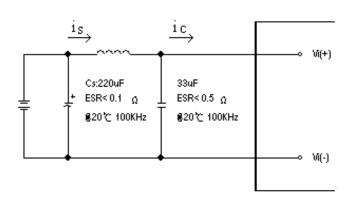


Figure 8: Output voltage response to step-change in load current $(50\%-75\%-50\% \text{ of Io, max; di/dt}=0.1\text{A/}\mu\text{s; Vin is 24V})$. Load cap: $10\mu\text{F}$ tantalum capacitor and $1\mu\text{F}$ ceramic capacitor. Top Trace: Vout (0.2V/div, 100us/div), Bottom Trace: Iout (10A/div). Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module

Figure 9: Output voltage response to step-change in load current (50%-75%-50% of Io, max; di/dt = $0.1A/\mu$ s; Vin is 48V). Load cap: 10μ F tantalum capacitor and 1μ F ceramic capacitor. Top Trace: Vout (0.2V/div, 100us/div), Bottom Trace: Iout (10A/div). Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module



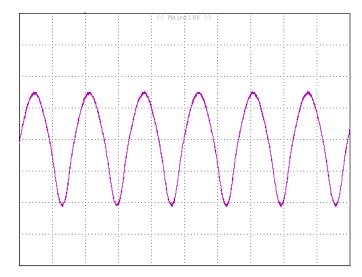
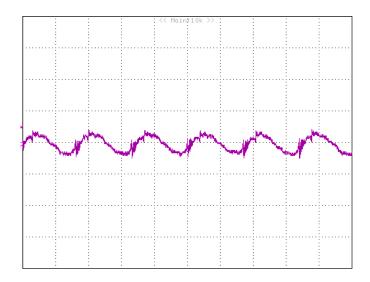


Figure 10: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

Note: Measured input reflected-ripple current with a simulated source Inductance (L_{TEST}) of 12 μ H. Capacitor Cs offset possible battery impedance. Measure current as shown above.

Figure 11: Input Terminal Ripple Current, i_c, at max output current and nominal input voltage with 12μH source impedance and 33μF electrolytic capacitor (500 mA/div, 2us/div).





Copper Strip

Vo(+)

10u

T

1u

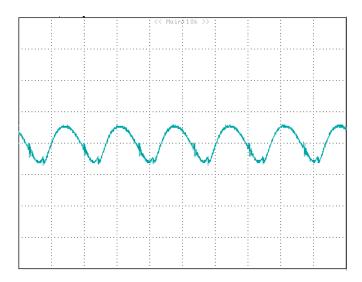
SCOPE

RESISTIVE

LOAD

Figure 12: Input reflected ripple current, i_s , through a $12\mu H$ source inductor at nominal input voltage and max load current (20 mA/div, 2us/div).

Figure 13: Output voltage noise and ripple measurement test setup.



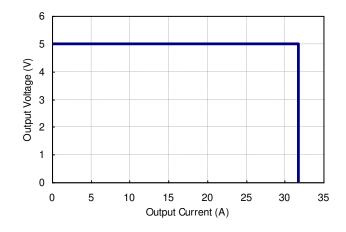


Figure 14: Output voltage ripple at nominal input voltage and max load current (50 mV/div, 2us/div)

Figure 15: Output voltage vs. load current showing typical current limit curves and converter shutdown points.

Load capacitance: 1µF ceramic capacitor and 10µF tantalum capacitor. Bandwidth: 20 MHz.



DESIGN CONSIDERATIONS

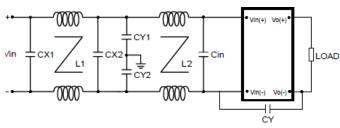
Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μ H, we advise 100 μ F electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Below is the reference design for an input filter tested with E36SC05025 to meet class B in CISSPR 22.

Schematic and Components List



Cin is 100uF low ESR Aluminum cap:

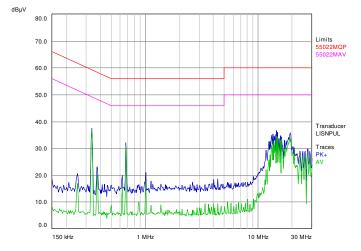
CY is 1nF ceramic cap:

CX1,CX2 are 2.2uF ceramic cap:

CY1,CY2 are 3.3nF ceramic cap:

L1,L2 are common-mode inductor,L1=L2=0.63mH:

Test Result: Vin=48V, lo=25A,



Blue Line is quasi peak mode; green line is average mode.

Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e., UL60950-1, CSA C22.2 NO. 60950-1 2nd and IEC 60950-1 2nd: 2005 and EN 60950-1 2nd: 2006+A11+A1: 2010, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a normal-blow fuse with 20A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the



reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

FEATURES DESCRIPTIONS

Over-Current Protection

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the modules will shut down (hiccup mode).

The modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the protection circuit will constrain the max duty cycle to limit the output voltage, if the output voltage continuously increases the modules will shut down, and then restart after a hiccup-time (hiccup mode).

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will restart after the temperature is within specification.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi (-) terminal. The switch can be an open collector or open drain. For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi (-). For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

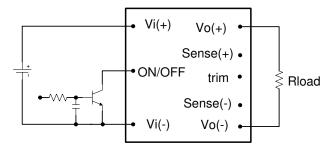


Figure 16: Remote on/off implementation

Output Voltage Adjustment (TRIM)

To increase or decrease the output voltage set point, connect an external resistor between the TRIM pin and either the SENSE(+) or SENSE(-). The TRIM pin should be left open if this feature is not used.

For trim down, the external resistor value required to obtain a percentage of output voltage change \triangle % is defined as:

$$Rtrim - down = \left[\frac{511}{\Delta} - 10.22\right] (K\Omega)$$

Ex. When Trim-down -20% (5.0V×0.8=4.0V)

$$Rtrim - down = \left[\frac{511}{20} - 10.22\right](K\Omega) = 15.33(K\Omega)$$

For trim up, the external resistor value required to obtain a percentage output voltage change $\triangle\%$ is defined as:

Rtrim - up =
$$\frac{5.11\text{Vo}(100 + \Delta)}{1.225\Delta} - \frac{511}{\Delta} - 10.22(K\Omega)$$

Ex. When Trim-up +10% (5.0V×1.1=5.5V)

$$Rtrim - up = \frac{5.11 \times 5.0 \times (100 + 10)}{1.225 \times 10} - \frac{511}{10} - 10.22 = 168(K\Omega)$$

The output voltage can be increased by both the remote sense and the trim, however the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power.



THERMAL CONSIDERATIONS

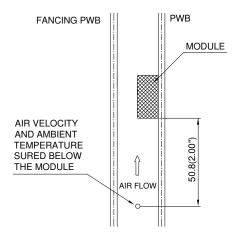
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 17: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.



THERMAL CURVES (WITHOUT HEAT SPREADER)

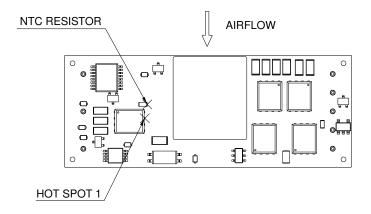


Figure 18: * Hot spot 1& NTC resistor temperature measured points. The allowed maximum hot spot temperature is defined at 116 $^{\circ}$ C.

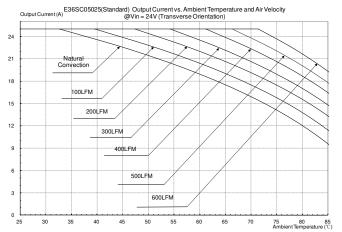


Figure 19: Output current vs. ambient temperature and air velocity @Vin=24V(Either Orientation, airflow from Vin+ to Vin-, without heat spreader)

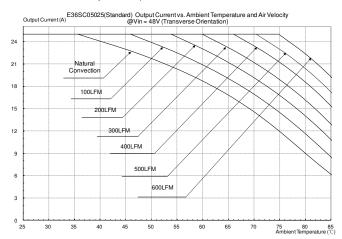


Figure 20: Output current vs. ambient temperature and air velocity @Vin=48V(Either Orientation, airflow from Vin+ to Vin-,without heat spreader)

THERMAL CURVES (WITH HEAT SPREADER)

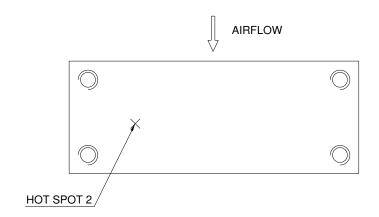


Figure 21: * Hot spot 2 temperature measured point. The allowed maximum hot spot temperature is defined at $105\,$ °C.

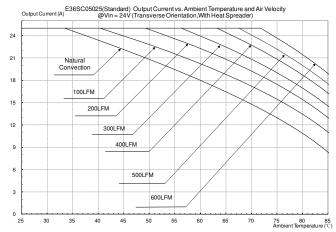


Figure 22: Output current vs. ambient temperature and air velocity @Vin=24V(Either Orientation, airflow from Vin+ to Vin-,with heat spreader)

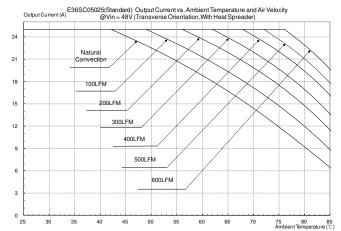
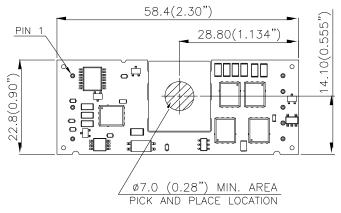


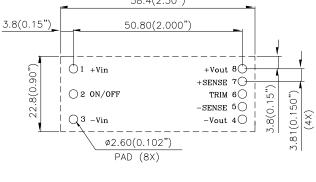
Figure 23: Output current vs. ambient temperature and air velocity @Vin=48V(Either Orientation, airflow from Vin+ to Vin-,with heat spreader)



PICK AND PLACE LOCATION

RECOMMENDED PAD LAYOUT (SMD) 58.4(2.30")





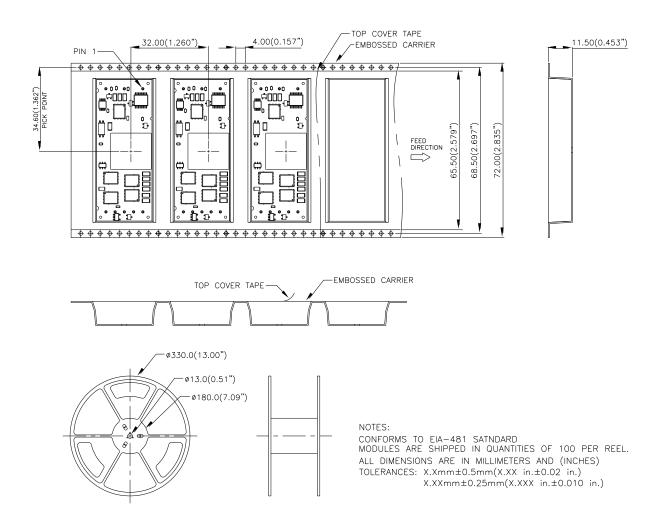
RECOMENDED P.W.B. PAD LAYOUT

DIMENSIONS ARE IN MILLIMETERS AND (INCHES) TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.) X.XXmm±0.25mm(X.XXX in.±0.010 in.)

NOTES:

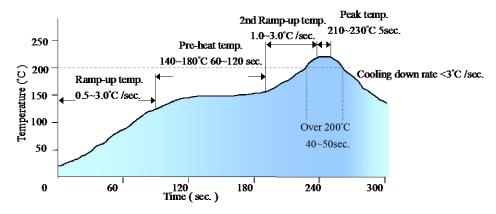
DIMENSIONS ARE IN MILLIMETERS AND (INCHES) TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.) X.XXmm±0.25mm(X.XXX in.±0.010 in.)

TAPE & REEL PACKAGE FOR SURFACE MOUNT MODELS



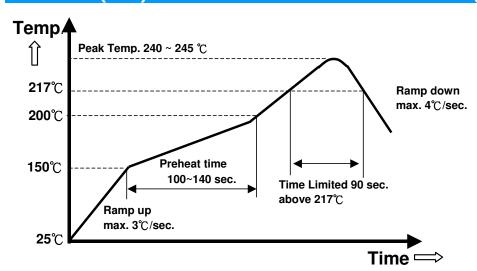


LEADED (Sn/Pb) PROCESS RECOMMEND TEMP. PROFILE(for SMD models)



Note: The temperature refers to the pin of E36SC, measured on the +Vout pin joint.

LEAD FREE (SAC) PROCESS RECOMMEND TEMP. PROFILE(for SMD models)

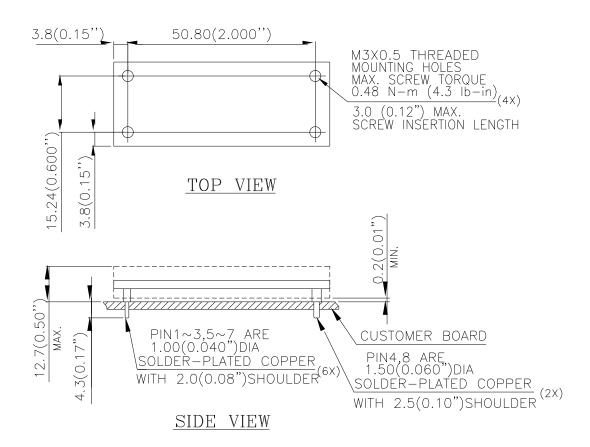


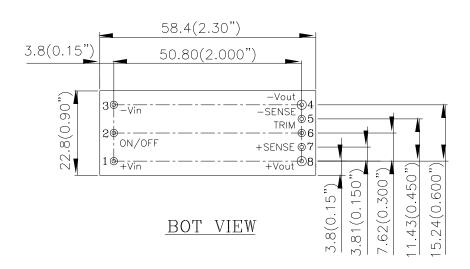
Note: The temperature refers to the pin of E36SC05025, measured on the +Vout pin joint.



MECHANICAL DRAWING (WITH HEAT SPREADER)

For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.





NOTES:

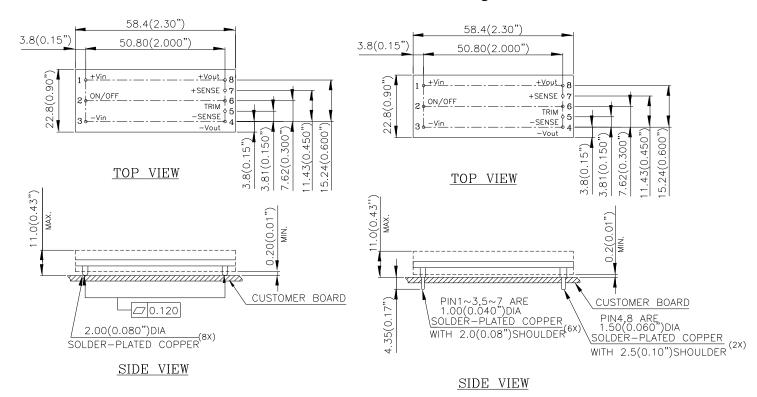
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)



MECHANICAL DRAWING (WITHOUT HEAT SPREADER)

Surface-mount module

Through-hole module



NOTES:

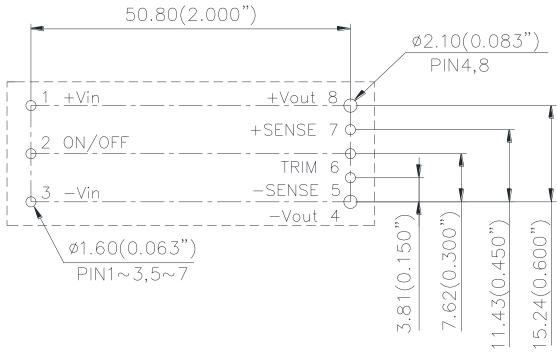
Pin No.	<u>Name</u>	<u>Function</u>		
1	+Vin	Positive input voltage		
2	ON/OFF	Remote ON/OFF		
3	-Vin	Negative input voltage		
4	-Vout	Negative output voltage		
5	-SENSE	Negative remote sense		
6	TRIM	Output voltage trim		
7	+SENSE	Positive remote sense		
8	+Vout	Positive output voltage		

Pin Specification:

Note: All pins are copper alloy with matte Tin(Pb free) plated over Nickel under plating.



RECOMMENDED PAD LAYOUT (THROUGH-HOLE MODULE)



RECOMMENDED P.W.B. PAD LAYOUT

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)

X.XXmm±0.25mm(X.XXX in.±0.010 in.)



PART NUMBERING SYSTEM									
E	36	S	С	050	25	N	K	F	A
Form	Input	Number of	Product	Output	Output	ON/OFF	Pin		Option Code
Factor	Voltage	Outputs	Series	Voltage	Current	Logic	Length		
E - 1/8	36-	S –	C-	050-	25-	N –	K – 0.110"	F - RoHS 6/6	A – Standard Function
Brick	18V~75V	Single	Series	5.0V	25A	Negative	N - 0.145" R - 0.170"	(Lead Free)	H– With Heatspreader
			Number				M - SMD pin	Space - RoHS5/6	

Note: E36SC05025NRFH is customer product not standard.

MODEL LIST							
MODEL NAME	INPUT		OU	TPUT	EFF @ 100% LOAD		
E36SC05025NKFA	18V~75V	8.9A	5.0V	25A	91.0% @ 48Vin		

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales office.

For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.

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